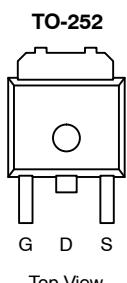


N-Channel 60-V (D-S), 175°C MOSFET, Logic Level

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A) ^a
60	0.022 @ $V_{GS} = 10$ V	30
	0.025 @ $V_{GS} = 4.5$ V	30

FEATURES

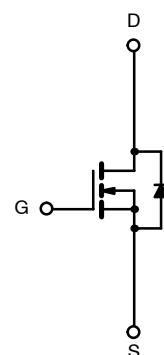
- TrenchFET® Power MOSFET
- 175°C Maximum Junction Temperature
- 100% R_g Tested



Drain Connected to Tab

Top View

Order Number:
SUD40N06-25L



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)			
Parameter	Symbol	Limit	Unit
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_J = 175^\circ\text{C}$) ^b	I_D ($T_C = 25^\circ\text{C}$)	30	A
	I_D ($T_C = 100^\circ\text{C}$)	30	
Pulsed Drain Current	I_{DM}	100	A
Continuous Source Current (Diode Conduction)	I_S	34	
Avalanche Current	I_{AR}	34	W
Repetitive Avalanche Energy (Duty Cycle $\leq 1\%$)	E_{AR}	58	
Maximum Power Dissipation	P_D ($T_C = 25^\circ\text{C}$)	75	W
	P_D ($T_A = 25^\circ\text{C}$)	1.4 ^b , 2.5 ^c	
Operating Junction and Storage Temperature Range	T_J , T_{stg}	-55 to 175	°C

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Maximum Junction-to-Ambient	R_{thJA} (Free Air, FR4 Board Mount)	60	°C/W
	R_{thJA} (Free Air, Vertical Mount)	110	
Maximum Junction-to-Case	R_{thJC}	2.0	

Notes:

- Package limited.
- Free air, vertical mount.
- Surface mounted on 1" x 1" FR4 Board, $t \leq 10$ sec.

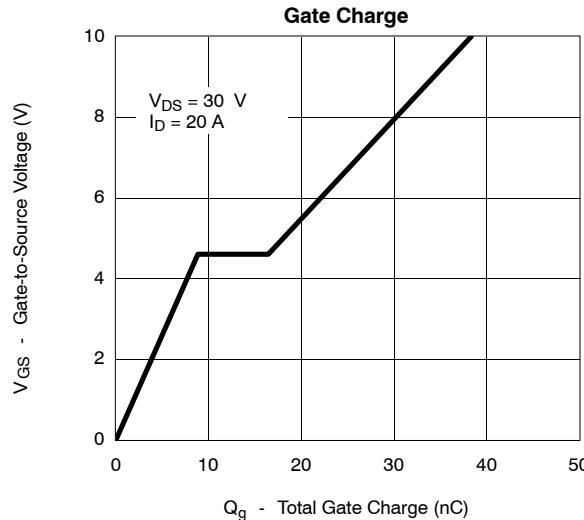
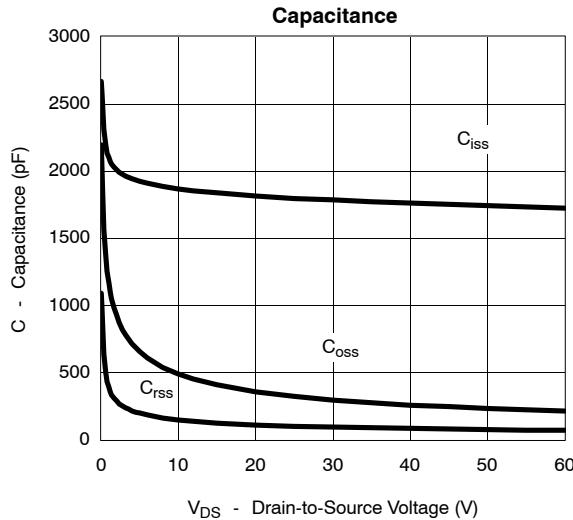
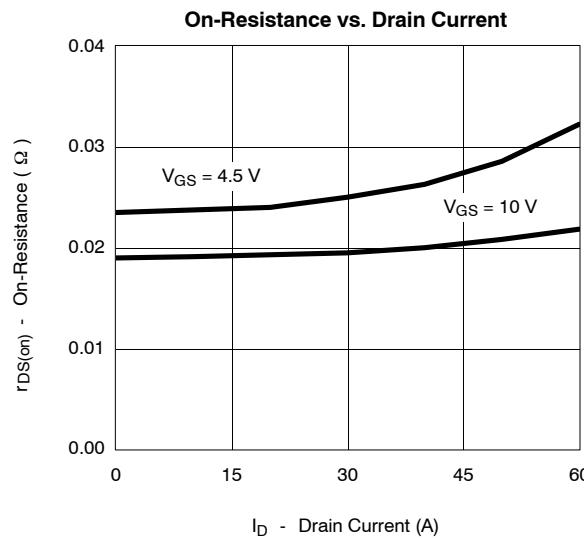
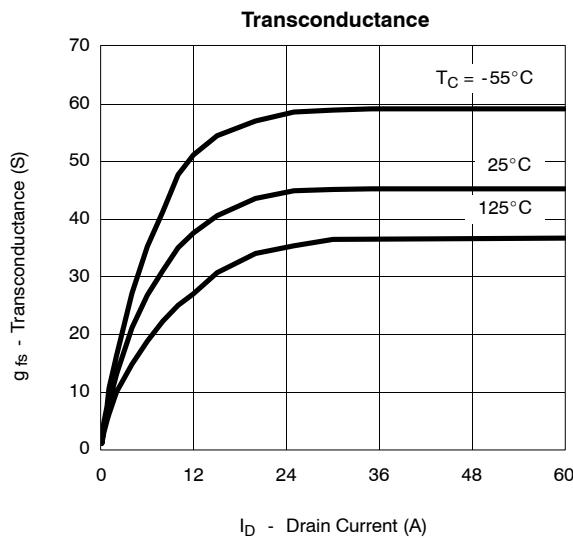
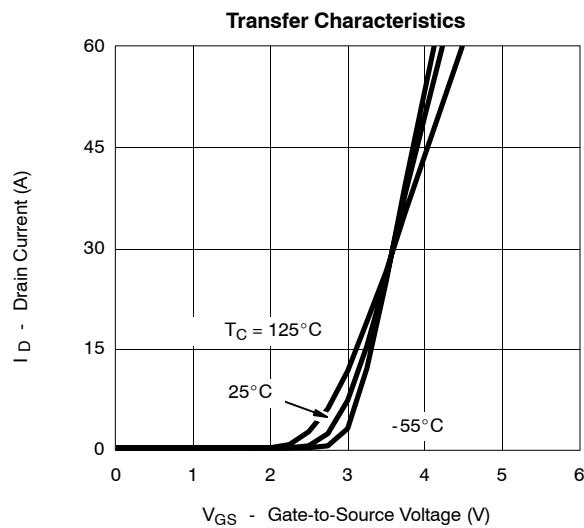
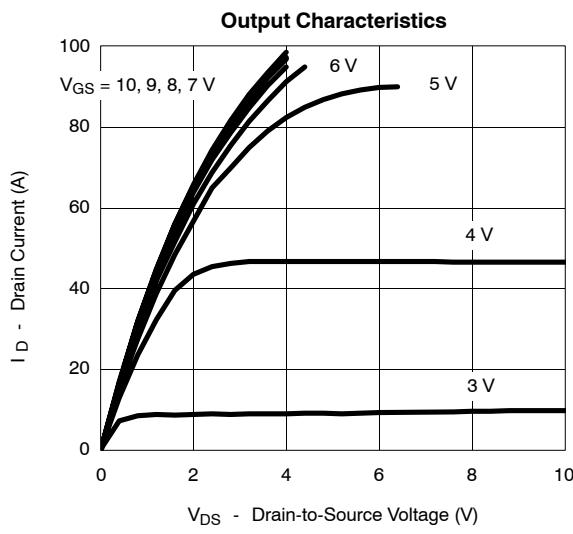
For SPICE model information via the Worldwide Web: <http://www.vishay.com/www/product/spice.htm>

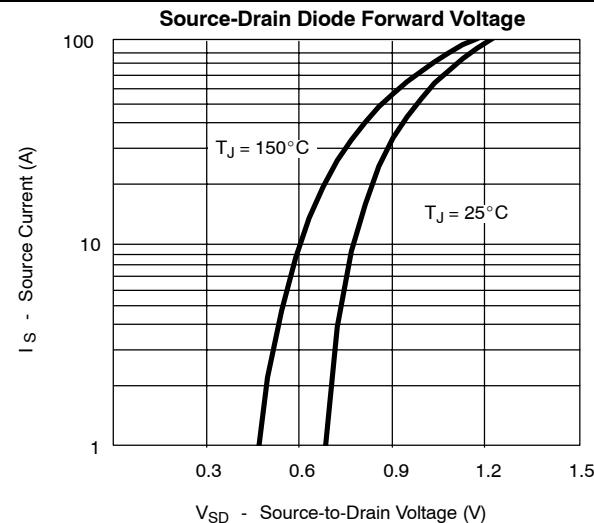
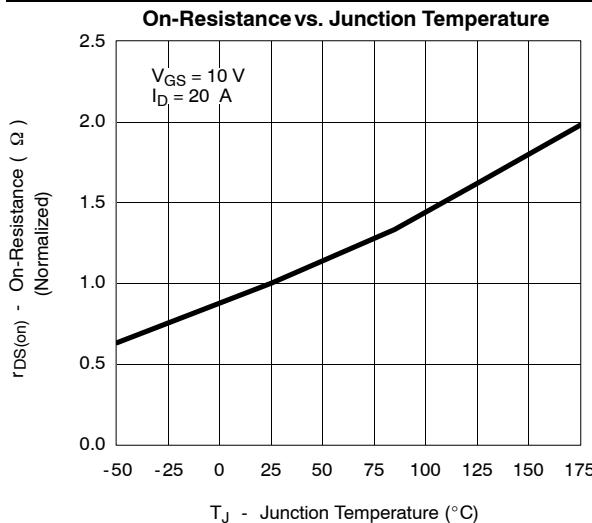
SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ ^a	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1.0	2.0	3.0	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		1		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$		50		μA
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 175^\circ\text{C}$		150		
On-State Drain Current ^b	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			A
Drain-Source On-State Resistance ^b	$r_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$			0.022	
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125^\circ\text{C}$			0.043	Ω
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 175^\circ\text{C}$			0.053	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$			0.025	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$				S
Dynamic						
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1800		
Output Capacitance	C_{oss}			350		pF
Reverse Transfer Capacitance	C_{rss}			100		
Total Gate Charge ^c	Q_g	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 40 \text{ A}$		40	60	
Gate-Source Charge ^c	Q_{gs}			9		nC
Gate-Drain Charge ^c	Q_{gd}			10		
Gate Resistance	R_g		1		3.5	Ω
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 30 \text{ V}, R_L = 0.9 \Omega$ $I_D \cong 20 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		10	20	
Rise Time ^c	t_r			9	20	ns
Turn-Off Delay Time ^c	$t_{d(off)}$			28	50	
Fall Time ^c	t_f			7	15	
Source-Drain Diode Ratings and Characteristics ($T_C = 25^\circ\text{C}$)						
Pulsed Current	I_{SM}				20	A
Diode Forward Voltage	V_{SD}	$I_F = 20 \text{ A}, V_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t_{rr}	$I_F = 20 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		48	100	ns

Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- c. Independent of operating temperature.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**THERMAL RATINGS**